

AS7C1024B

5V 128K X 8 HIGH SPEED CMOS SRAM

Revision History AS7C1024B

Revision	Details	Date
Rev 1.0	Preliminary datasheet	prior to 2004
Rev 1.1	Die Revision A to B	March 2004
Rev 2.0	PCN issued yield issues with industrial temperature TJ = SOJ 300 mil-10/12ns	May 2015

*Please note we will still offer 10/12/15/20 ns address access speed options in commercial temperatures in other packages

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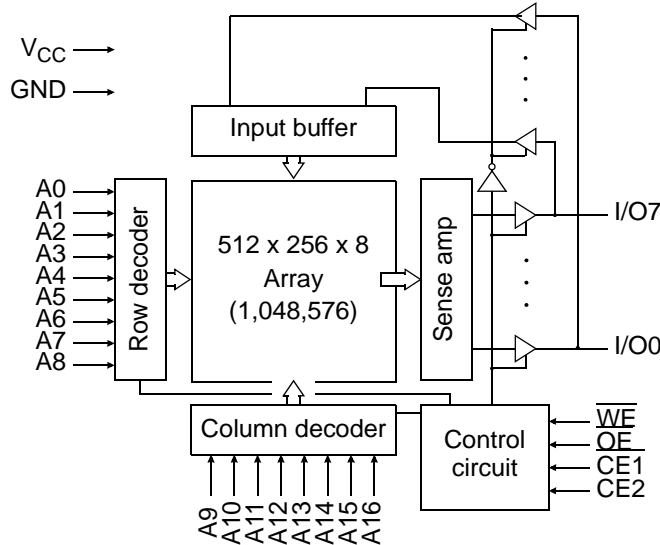


5V 128K X 8 CMOS SRAM

Features

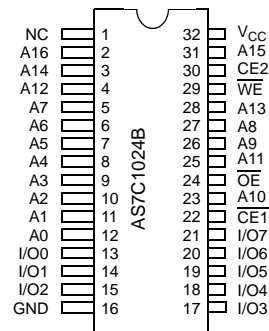
- Industrial and commercial temperatures
- Organization: 131,072 words x 8 bits
- High speed
 - 10/12/15/20 ns address access time
 - 5/6/7/8 ns output enable access time
- Low power consumption: ACTIVE
 - 605 mW / max @ 10 ns
- Low power consumption: STANDBY
 - 55 mW / max CMOS
- 6T 0.18u CMOS technology
- Easy memory expansion with $\overline{CE1}$, $\overline{CE2}$, \overline{OE} inputs
- TTL/LVTTL-compatible, three-state I/O
- 32-pin JEDEC standard packages
 - 300 mil SOJ
 - 400 mil SOJ
 - 8 x 20mm TSOP 1
 - 8 x 13.4mm sTSOP 1
- ESD protection ≥ 2000 volts
- Latch-up current ≥ 200 mA

Logic block diagram

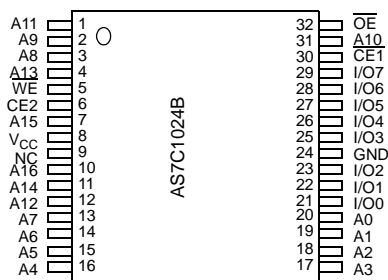


Pin arrangement

32-pin SOJ (300 mil)
32-pin SOJ (400 mil)



32-pin (8 x 20mm) TSOP 1
32-pin (8 x 13.4mm) sTSOP1



Selection guide

	-10	-12	-15	-20	Unit
Maximum address access time	10	12	15	20	ns
Maximum output enable access time	5	6	7	8	ns
Maximum Operating Current	110	100	90	80	mA
Maximum CMOS standby Current	10	10	10	10	mA



Functional description

The AS7C1024B is a high performance CMOS 1,048,576-bit Static Random Access Memory (SRAM) device organized as 131,072 words x 8 bits. It is designed for memory applications where fast data access, low power, and simple interfacing are desired.

Equal address access and cycle times (t_{AA} , t_{RC} , t_{WC}) of 10/12/15/20 ns with output enable access times (t_{OE}) of 5/6/7/8 ns are ideal for high performance applications. Active high and low chip enables ($\overline{CE1}$, CE2) permit easy memory expansion with multiple-bank systems.

When $\overline{CE1}$ is high or CE2 is low, the devices enter standby mode. If inputs are still toggling, the device will consume I_{SB} power. If the bus is static, then full standby power is reached (I_{SB1}). For example, the AS7C1024B is guaranteed not to exceed 55 mW under nominal full standby conditions.

A write cycle is accomplished by asserting write enable (\overline{WE}) and both chip enables ($\overline{CE1}$, CE2). Data on the input pins I/O0 through I/O7 is written on the rising edge of \overline{WE} (write cycle 1) or the active-to-inactive edge of $\overline{CE1}$ or CE2 (write cycle 2). To avoid bus contention, external devices should drive I/O pins only after outputs have been disabled with output enable (\overline{OE}) or write enable (\overline{WE}).

A read cycle is accomplished by asserting output enable (\overline{OE}) and both chip enables ($\overline{CE1}$, CE2), with write enable (\overline{WE}) high. The chips drive I/O pins with the data word referenced by the input address. When either chip enable is inactive, output enable is inactive, or write enable is active, output drivers stay in high-impedance mode.

Absolute maximum ratings

Parameter	Symbol	Min	Max	Unit
Voltage on V_{CC} relative to GND	V_{t1}	-0.50	+7.0	V
Voltage on any pin relative to GND	V_{t2}	-0.50	$V_{CC} + 0.50$	V
Power dissipation	P_D	-	1.0	W
Storage temperature (plastic)	T_{stg}	-65	+150	°C
Ambient temperature with V_{CC} applied	T_{bias}	-55	+125	°C
DC current into outputs (low)	I_{OUT}	-	20	mA

Note: Stresses greater than those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions outside those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

Truth table

CE1	CE2	\overline{WE}	\overline{OE}	Data	Mode
H	X	X	X	High Z	Standby (I_{SB} , I_{SB1})
X	L	X	X	High Z	Standby (I_{SB} , I_{SB1})
L	H	H	H	High Z	Output disable (I_{CC})
L	H	H	L	D_{OUT}	Read (I_{CC})
L	H	L	X	D_{IN}	Write (I_{CC})

Key: X = don't care, L = low, H = high



Recommended operating conditions

Parameter		Symbol	Min	Nominal	Max	Unit
Supply Voltage		V_{CC}	4.5	5.0	5.5	V
Input Voltage		V_{IH}	2.2	-	$V_{CC} + 0.5$	V
		V_{IL}	-0.5	-	0.8	V
Ambient operating temperature	commercial	T_A	0	-	70	°C
	industrial	T_A	-40	-	85	°C

V_{IL} min = -1.0V for pulse width less than 5ns

V_{IH} max = $V_{CC} + 2.0V$ for pulse width less than 5ns.

DC operating characteristics (over the operating range)¹

Parameter	Sym	Test conditions	-10		-12		-15		-20		Unit
			Min	Max	Min	Max	Min	Max	Min	Max	
Input leakage current	$ I_{LI} $	$V_{CC} = \text{Max}, V_{IN} = \text{GND to } V_{CC}$	-	1	-	1	-	1	-	1	μA
Output leakage current	$ I_{LO} $	$V_{CC} = \text{Max}, \text{CE1} = V_{IH} \text{ or } \text{CE2} = V_{IL}, V_{OUT} = \text{GND to } V_{CC}$	-	1	-	1	-	1	-	1	μA
Operating power supply current	I_{CC}	$V_{CC} = \text{Max}, \overline{\text{CE1}} \leq V_{IL}, \text{CE2} \geq V_{IH}, f = f_{\text{Max}}, I_{\text{OUT}} = 0 \text{ mA}$	-	110	-	100	-	90	-	80	mA
Standby power supply current	I_{SB}	$V_{CC} = \text{Max}, \text{CE1} \geq V_{IH} \text{ and/or } \text{CE2} \leq V_{IL}, f = f_{\text{Max}}$	-	50	-	45	-	45	-	40	mA
	I_{SB1}	$V_{CC} = \text{Max}, \text{CE1} \geq V_{CC} - 0.2V \text{ and/or } \text{CE2} \leq 0.2V, V_{IN} \leq 0.2V \text{ or } V_{IN} \geq V_{CC} - 0.2V, f = 0$	-	10	-	10	-	10	-	10	
Output voltage	V_{OL}	$I_{OL} = 8 \text{ mA}, V_{CC} = \text{Min}$	-	0.4	-	0.4	-	0.4	-	0.4	V
	V_{OH}	$I_{OH} = -4 \text{ mA}, V_{CC} = \text{Min}$	2.4	-	2.4	-	2.4	-	2.4	-	

Capacitance ($f = 1 \text{ MHz}, T_a = 25 \text{ }^\circ\text{C}, V_{CC} = \text{NOMINAL}$)²

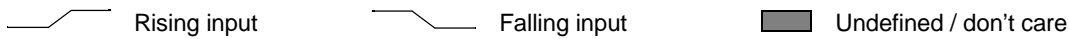
Parameter	Symbol	Signals	Test conditions	Max	Unit
Input capacitance	C_{IN}	A, CE1, CE2, WE, OE	$V_{IN} = 0V$	5	pF
I/O capacitance	$C_{I/O}$	I/O	$V_{IN} = V_{OUT} = 0V$	7	pF



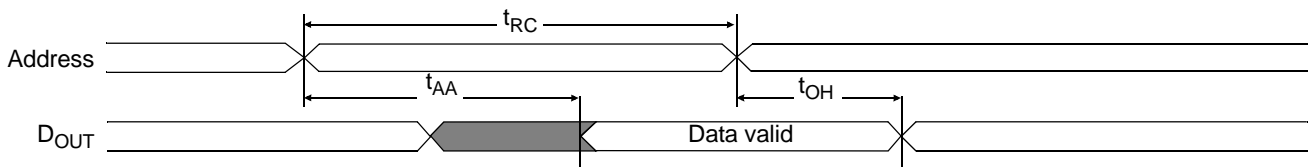
Read cycle (over the operating range)^{3,9,12}

Parameter	Symbol	-10		-12		-15		-20		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
Read cycle time	t_{RC}	10	-	12	-	15	-	20	-	ns	
Address access time	t_{AA}	-	10	-	12	-	15	-	20	ns	3
Chip enable (CE1) access time	t_{ACE1}	-	10	-	12	-	15	-	20	ns	3, 12
Chip enable (CE2) access time	t_{ACE2}	-	10	-	12	-	15	-	20	ns	3, 12
Output enable (OE) access time	t_{OE}	-	5	-	6	-	7	-	8	ns	
Output hold from address change	t_{OH}	3	-	3	-	3	-	3	-	ns	5
CE1 Low to output in low Z	t_{CLZ1}	3	-	3	-	3	-	3	-	ns	4, 5, 12
CE2 High to output in low Z	t_{CLZ2}	3	-	3	-	3	-	3	-	ns	4, 5, 12
CE1 Low to output in high Z	t_{CHZ1}	-	4	-	5	-	6	-	7	ns	4, 5, 12
CE2 Low to output in high Z	t_{CHZ2}	-	4	-	5	-	6	-	7	ns	4, 5, 12
OE Low to output in low Z	t_{OLZ}	0	-	0	-	0	-	0	-	ns	4, 5
OE High to output in high Z	t_{OHZ}	-	4	-	5	-	6	-	7	ns	4, 5
Power up time	t_{PU}	0	-	0	-	0	-	0	-	ns	4, 5, 12
Power down time	t_{PD}	-	10	-	12	-	15	-	20	ns	4, 5, 12

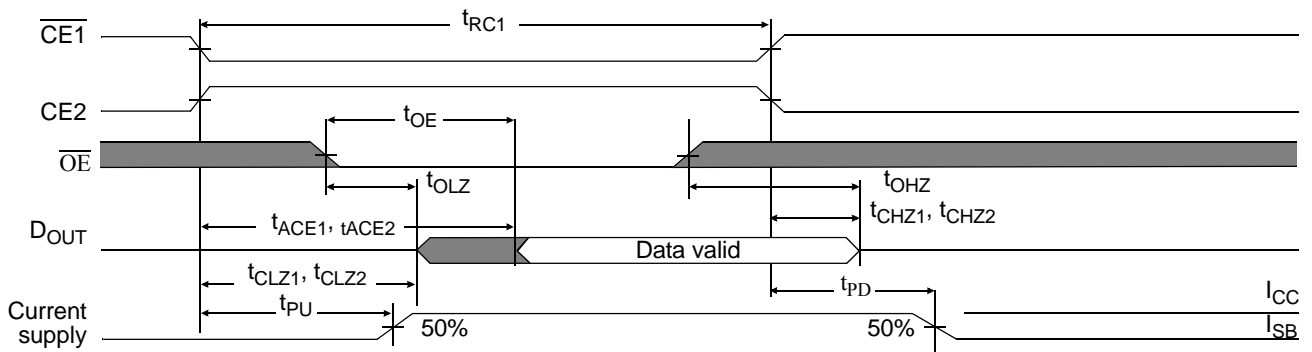
Key to switching waveforms



Read waveform 1 (address controlled)^{3,6,7,9,12}



Read waveform 2 ($\overline{CE1}$, $\overline{CE2}$, and \overline{OE} controlled)^{3,6,8,9,12}

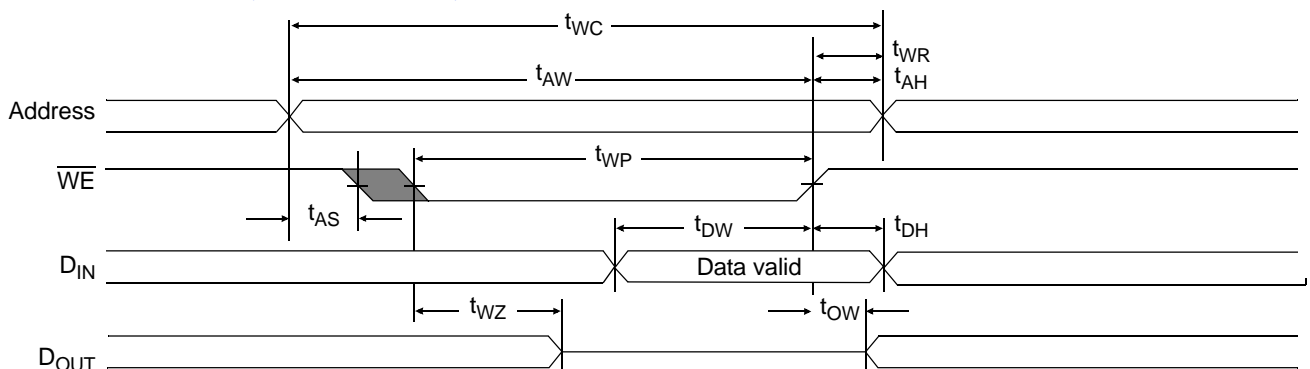




Write cycle (over the operating range)^{11, 12}

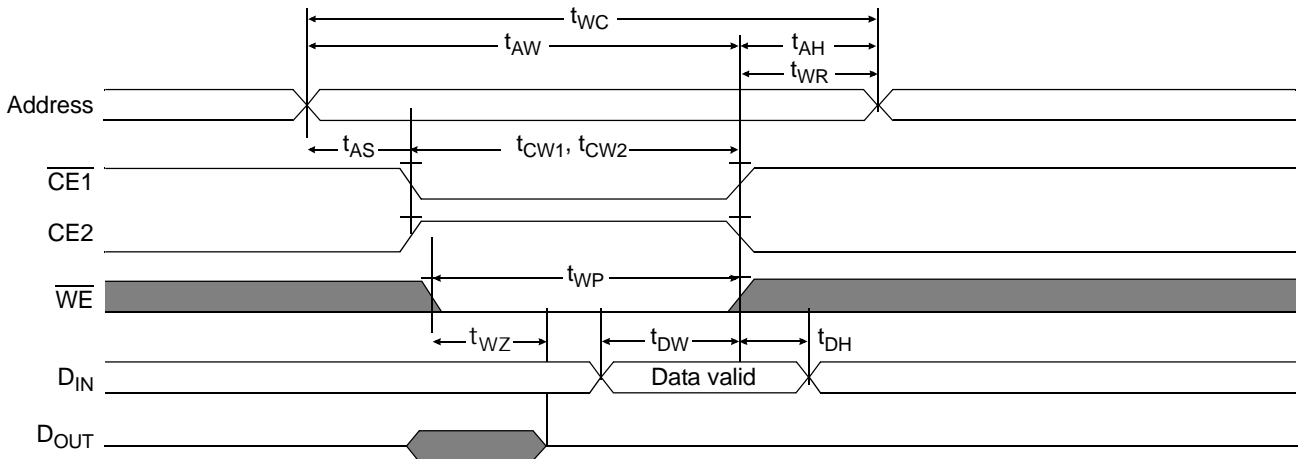
Parameter	Symbol	-10		-12		-15		-20		Unit	Notes
		Min	Max	Min	Max	Min	Max	Min	Max		
Write cycle time	t_{WC}	10	-	12	-	15	-	20	-	ns	
Chip enable (CE1) to write end	t_{CW1}	8	-	9	-	10	-	12	-	ns	12
Chip enable (CE2) to write end	t_{CW2}	8	-	9	-	10	-	12	-	ns	12
Address setup to write end	t_{AW}	8	-	9	-	10	-	12	-	ns	
Address setup time	t_{AS}	0		0	-	0	-	0	-	ns	12
Write pulse width	t_{WP}	7		8	-	9	-	12	-	ns	
Write recovery time	t_{WR}	0	-	0	-	0	-	0	-	ns	
Address hold from end of write	t_{AH}	0	-	0	-	0	-	0	-	ns	
Data valid to write end	t_{DW}	5		6	-	8	-	10	-	ns	
Data hold time	t_{DH}	0		0	-	0	-	0	-	ns	4, 5
Write enable to output in high Z	t_{WZ}	-	5	-	6	-	7	-	8	ns	4, 5
Output active from write end	t_{OW}	1	-	1	-	1	-	2	-	ns	4, 5

Write waveform 1 (\overline{WE} controlled)^{10,11,12}





Write waveform 2 (CE1 and CE2 controlled)^{10,11,12}



AC test conditions

- Output load: see Figure B.
- Input pulse level: GND to 3.5V. See Figure A.
- Input rise and fall times: 2 ns. See Figure A.
- Input and output timing reference levels: 1.5V.

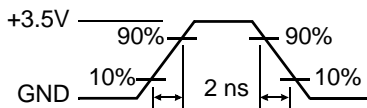


Figure A: Input pulse

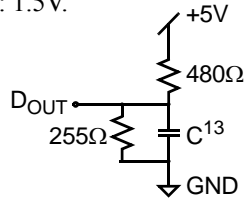
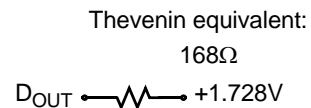


Figure B: 5V Output load

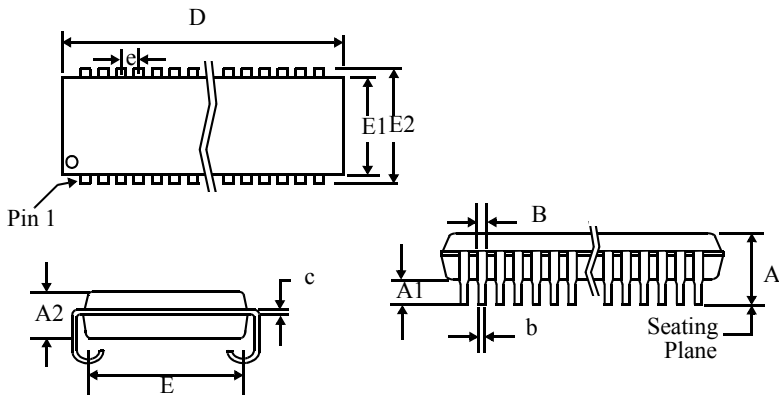


Notes

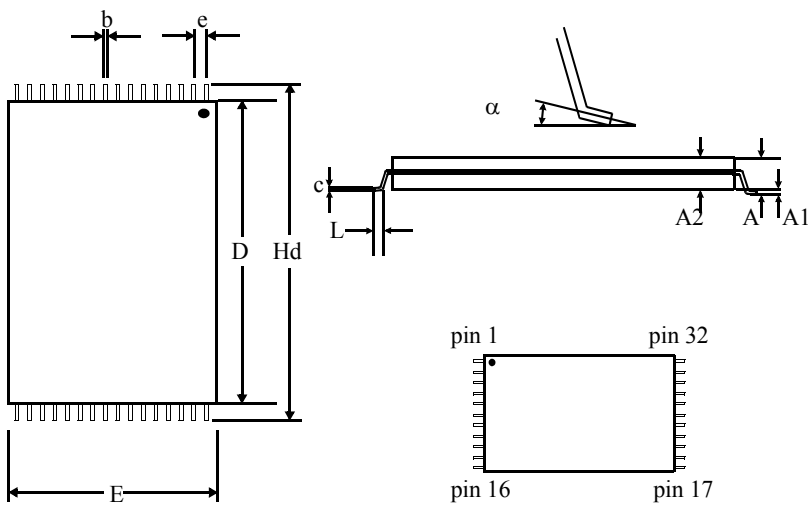
- 1 During V_{CC} power-up, a pull-up resistor to V_{CC} on $\overline{CE1}$ is required to meet I_{SB} specification.
- 2 This parameter is sampled and not 100% tested.
- 3 For test conditions, see *AC Test Conditions*, Figures A and B.
- 4 t_{CLZ} and t_{CHZ} are specified with $C_L = 5\text{pF}$, as in Figure C. Transition is measured $\pm 500\text{mV}$ from steady-state voltage.
- 5 This parameter is guaranteed, but not 100% tested.
- 6 \overline{WE} is high for read cycle.
- 7 $\overline{CE1}$ and \overline{OE} are low and $CE2$ is high for read cycle.
- 8 Address valid prior to or coincident with $\overline{CE1}$ transition Low.
- 9 All read cycle timings are referenced from the last valid address to the first transitioning address.
- 10 N/A
- 11 All write cycle timings are referenced from the last valid address to the first transitioning address.
- 12 $\overline{CE1}$ and $CE2$ have identical timing.
- 13 $C = 30\text{pF}$, except all high Z and low Z parameters where $C = 5\text{pF}$.



Package dimensions



	32-pin SOJ 300 mil		32-pin SOJ 400 mil	
	Min	Max	Min	Max
A	0.128	0.145	0.132	0.146
A1	0.025	-	0.025	-
A2	0.095	0.105	0.105	0.115
B	0.026	0.032	0.026	0.032
b	0.016	0.020	0.015	0.020
c	0.007	0.010	0.007	0.013
D	0.820	0.830	0.820	0.830
E	0.255	0.275	0.354	0.378
E1	0.295	0.305	0.395	0.405
E2	0.330	0.340	0.435	0.445
e	0.050 BSC		0.050 BSC	



	32-pin TSOP 8x20 mm	
	Min	Max
A	-	1.20
A1	0.05	0.15
A2	0.95	1.05
b	0.17	0.27
c	0.10	0.21
D	18.30	18.50
e	0.50 nominal	
E	7.90	8.10
Hd	19.80	20.20
L	0.50	0.70
α	0°	5°



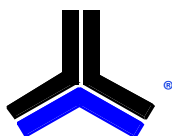
Ordering codes

Package \ Access time	Temp	10 ns	12 ns	15 ns	20 ns
Plastic SOJ, 300 mil	commercial	AS7C1024B-10TJC	AS7C1024B-12TJC	AS7C1024B-15TJC	AS7C1024B-20TJC
	industrial	–	AS7C1024B-12TJI	AS7C1024B-15TJI	AS7C1024B-20TJI
Plastic SOJ, 400 mil	commercial	AS7C1024B-10JC	AS7C1024B-12JC	AS7C1024B-15JC	AS7C1024B-20JC
	industrial	–	AS7C1024B-12JI	AS7C1024B-15JI	AS7C1024B-20JI
TSOP1 8×20 mm	commercial	AS7C1024B-10TC	AS7C1024B-12TC	AS7C1024B-15TC	AS7C1024B-20TC
	-				
sTSOP1 8 x 13.4mm	commercial	AS7C1024B-10STC	AS7C1024B-12STC	AS7C1024B-15STC	AS7C1024B-20STC
	industrial	–	AS7C1024B-12STI	AS7C1024B-15STI	AS7C1024B-20STI

Note: Add suffix 'N' to the above part number for LEAD FREE PARTS (Ex: AS7C1024B-10TCN)

Part numbering system

AS7C	1024B	-XX	X	X	X
SRAM prefix	Device number	Access time	Package: T = TSOP1 8×20 mm ST = sTSOP1 8 x 13.4 mm J = SOJ 400 mil TJ = SOJ 300 mil	Temperature range C = Commercial, 0° C to 70° C I = Industrial, -40° C to 85° C	N = LEAD FREE PART



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